To: VIVO MOBILE COMMUNICATION CO., LTD

Specification number: EQM08-1KC-E182K02

Date of issue: 2 February, 2018

Multilayer ceramic Chip capacitor specification

Product Part No

CM05X5R105K25AH CM05X5R105K16AH

(Recipient stamp column)
Please send back with recipient stamp or signature here.
This specification would be invalidated unlesse sent back

within a year after issue date of this specification.

RoHS Compliant

Kyocera Corporation Capacitor Division



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No.	Date	Contents	PREPD.	CHKD.	CHKD.	Page2/
1	2018/02/02	NEW				



1.Scope

This specification sheet shall be applied to multilayer ceramic chip capacitors; Kyocera CM series.

2.Nomenclature

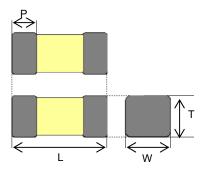
<u>CM</u>						<u>A</u>	
Series	(1)	(2)	(3)	(4)	(5)	(6)	(7)

(1) : Size

(2) : Temperature Characteristics

(3): Capacitance(4): Tolerance(5): Rated Voltage(6): External Electrode(7): Packaging

(1)External Dimensions(Size)



External Dimension for Taping or Bulk (unit:mm)					
Туре	L	W	Т	Р	
0E	1.00±0.05	0.50±0.05	0.50±0.05	0.15~0.35	
05	1.00±0.10	0.50±0.10	0.50±0.10	0.15~0.35	

(2)Temperature Characteristics

Characteristics	Applied voltage	Change in capacitance	Operating temperature range	Reference
X5R	No applied voltage	Within +/-15%	-55°C~+85°C	25°C



(3)Capacitance Value

Capacitance is indicated by three numbers and a letter (see example as follows). The first and second digits indicate the first two significant figures,and the final digit is a base 10 logarithmic multiplier in picofarads.

(Ex.)	
Code	Capacitance
105	1,000,000pF

(4)Tolerance

Code	K
Tolerance	±10%

(5)Rated Voltage

Code	16	25
Voltage	16Vdc	25Vdc

(6)Termination (External Electrode)

A: Nickel Barrier / Tin

(7)Packaging Configuration

Code	Packaging Configuration	Applying Size
Н	Taping(2mm Pitch. Φ180 Reel)	Refer to Taping specification

3. Operating temperature range

Refer to Item 2-(2)



4. Specifications and Test Methods

(Table 1-1)

	14	Specification	Management Completions
	Item	X5R	Measuring Conditions
Capacitance		Within specified tolerance value	High Temperature Treatment (Table 2)
			C≤10µF Measuring frequency 1kHz±10%
tanδ		Refer to (Table 3)	Measuring voltage Refer to (Table 3)
(*1)Insulation	Resistance	Refer to (Table 3)	Measure after charging with the rated voltage within 1 minutes at room conditions.
(*1)Dielectric	Strength	No problem observed	Applying 2.5 times of the rated voltage for 1 to 5 seconds.
Appearance		No serious defect	Under Microscope
End Termination adherence		No evidence of peeling on the end termination	After soldering chip capacitors on glass epoxy boards and applying 5N(0.5Kgf) as shown by the arrow mark in the sketch peeling or any sign of peeling should not be found on end terminations. (Refer to Fig.1)
Resistance to Vibration	Appearance	No serious defect	Perform High Temperature Treatment (Table 2) , then measure the initial capacitance and $tan\delta$.
Vibration	Capacitance Variation	Within specified tolerance value	Vibration frequency:10 to 55 (Hz) Swing width :1.5mm
	tanδ	Satisfies initial specified value	——Sweep :10→55→10 Hz/1min x,y,z axis 2 hours/each Total 6 hours
			(Refer to Fig.2)
Resistance to	Appearance	No serious defect	Perform High Temperature Treatment (Table 2) , then measure the initial capacitance and tanδ.
Solder Leaching	Capacitance Variation	Within ±7.5%	After dipped molten solder,
	tanδ	Satisfies initial specified value	at 260±5°C for 10±0.5 seconds and kept at room conditions for 24±2 hours,
	(*1)Insulation Resistance	Within specified tolerance value	measure and check the specifications.
	(*1)Dielectric Strength	Resist without problem.	*Pre-heat before immersion 1st: 80°C to 100°C for 120sec. 2st:150°C to 200°C for 120sec.
Solderability		Coverage >= 90% Each termination end	Soaking Condition <sn-3ag-0.5cu> 245±5°C 3±0.5sec. <sn63 solder=""> 235±5°C 2±0.5sec.</sn63></sn-3ag-0.5cu>



(Table 1-2)

	14	Specification	Management Complitions
	Item	X5R	Measuring Conditions
Temperature Appearance Cycling		No serious defect	Perform High Temperature Treatment (Table 2) , then measure the initial capacitance and $tan\delta$.
	Capacitance Variation	Refer to (Table 4)	<cycle> Room temperature (3 minutes) -</cycle>
	tanδ	Satisfies initial specified value	Lowest operating temperature (30 minutes) – Room temperature (3 minutes) – Highest operating temperature (30 minutes).
	(*1)Insulation Resistance	Refer to (Table 4)	After 5 cycles of the above, keep for after 24±2 hours at room conditions then measure.
	(*1)Dielectric Strength	Resist without problem	(Refer to Fig.2)
Load Humidity Resistance	Appearance	No serious defect	Perform Voltage Treatment (Table 2), then measure the initial capacitance and tanδ.
resistance	Capacitance Variation	Refer to (Table 4)	After applying rated voltage at 40±2°C and humidity 90 to 95%RH,for 500+12/-0
	tanδ	Less than 2.0 times of the initial value	hours and keep at room condition for 24±2 hours then measure and check the specification limits.
	(*1)Insulation Resistance	Refer to (Table 4)	check the specification limits.
High Temperature Life	Appearance	No serious defect	Perform Voltage Treatment (Table 2), then measure the initial capacitance and tanδ.
Test	Capacitance Variation	Refer to (Table 4)	After applying voltage (Magnification of Applied voltage × Rated voltage) for
	tanδ	Less than 2.0 times of the initial value	-1000+12/-0 hours in pre-condition at the highest temperature, allow parts to stabilize for 24±2 hours, at room temperature before
	(*1)Insulation Resistance	Refer to (Table 4)	measurement. * Magnification of Applied voltage: refer to (Table 4)
Bending Strength		No mechanical damage	Refer to Fig.3-1, Fig.3-2 The glass epoxy board is bent up 1mm in 10 sec.

(*1) Insulation Resistance/Dielectric Strength; Charging or discharging current for these tests Is limited under 50mA.

(Table 2)

Initial	High Temperature Treatment	Keep chip capacitor at 150°C +0/-10°C for 1 hour,Then leave chip capacitor at room temperature and normal humidity for 24±2 hours.
Treatment	Voltage Treatment	Pretreat capacitor for 1 hour at the same condition of the load test, Then leave them at room condition for 24±2 hours before beginning the Load test.



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[Table3 Parts List]

Product Part No		Dimension [mm]		tanδ	IR	Capacitance/	
	L	w	Т	[%]max	(initial) min	tanδ Measuring voltage	
CM05X5R105K25AH	1.00±0.10	0.50±0.10	0.50±0.10	10.0%	50 MΩ•μF	1.0±0.2Vrms	
CM05X5R105K16AH	1.00±0.05	0.50±0.05	0.50±0.05	12.5%	100 MΩ•μF	1.0±0.2Vrms	

[Table4 test specifications]

[Tuble+ test specifications]							
Product Part No	Temperature Cycling		Load Humidity Resistance		High Temperature Life Test		
	Capacitance IR C		Capacitance	IR	Voltage	Capacitance	IR
	Variation	(Minimum	Variation	(Minimum	Bias [%]	Variation	(Minimum
		value)		value)			value)
CM05X5R105K25AH	±12.5%	20 MΩ•μF	±25.0%	10 MΩ•μF	100%	±25.0%	10 MΩ•μF
CM05X5R105K16AH	±12.5%	20 MΩ•μF	±25.0%	10 MΩ•μF	120%	±25.0%	10 MΩ•μF



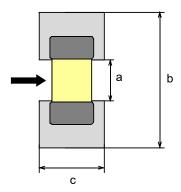


Fig.1 Substrate for adhesion strength test

type	а	b	С
05	0.4	1.4	0.5

glass epoxy board

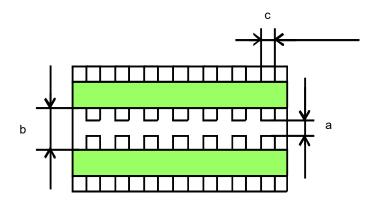


Fig.2 Substrate for temperature cycle test

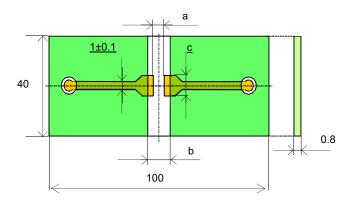


Fig.3-1 Substrate for bending test

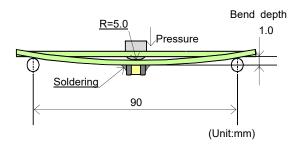
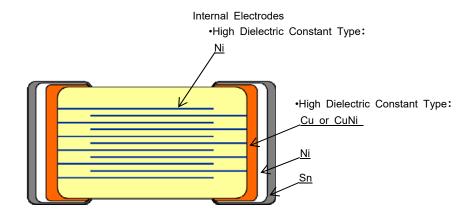


Fig.3-2 Testing status



[Structure]



[Production facility]

Kagoshima Kokubu plant



Taping Specification

1.Application

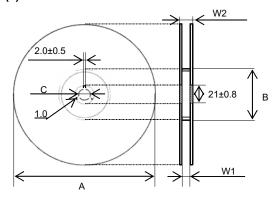
This specification applies to paper carrier tape of Kyocera multi-layer ceramic chip capacitor.

2.Packing unit

type	thickness (unit:mm)	material of carrier tape		width of carrier tape		Φ180 reel quantity	
		paper	Plastic	8mm	12mm	per reel	
05	0.50±0.05	0				40000	
	0.50±0.10	O	-	O	ı	10000	

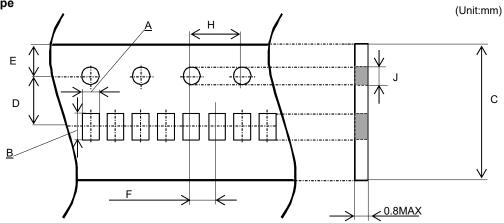
3. Shape and dimentions

(1)Reel



[Dimension]		Unit:mm	
	Α	В	С
Ф180 reel (Code:H)	Ф180+0/-2.0	Ф60min	Ф13.0±0.5
	W1	W2	
Ф180 reel (Code:H)	10.0±1.5	16.5max	

(2)Carrier Tape



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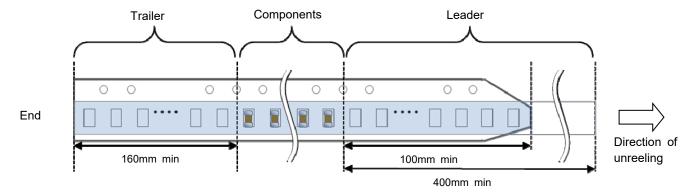
								(91111111111111111111111111111111111111
Code	Α	В	С	D	Е	F	Н	J
Tolerance Type	±0.1	±0.1	±0.3	±0.05	±0.1	±0.05	±0.1	+0.1/-0
05	0.65	1.15	8.0	3.5	1.75	2.0	4.0	φ1.5



4.Packing method

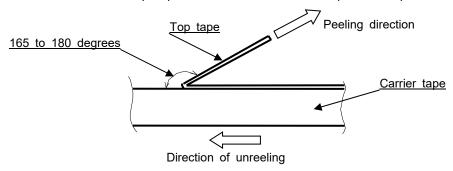
(1)Details of leader and trailer

- The tape will have a empty pocket at the leader and trailer of carrier tape.
- The tape end will not be stucked by glue in order to make it easier to peel off from reel.
- 3The feeding round hole will be on the right side against t leading direction.



(2)Heat pressure tape

- ①Peeling strength to be 0.1~0.7N when peeling off the top tape by following method.
- @When peeling top tape off, the glue will be stuck to the top tape side.
- 3 Chip capacitor will not stuck on heat pressure tape and will be free in the cavity.



The peel-off angle:165~180 degree against the surface of carrier tape.

The peel-off speed:300mm/min.

The peci-on speed.ooonini/min.

(3)Carrier tape

- ①Chip will not fall off from carrier tape or carrier tape will not be damaged by bending than within aradius of 25mm.
- ©The chip are inserted continuously without any empty pocket.
- (3) Chip will not be mis-mounted because of too big clearance between components and cavity. Also the waste of carrier tape will not fill a nozzle hole of mouting machine.

5.Indication and packing

- ①There will be following indication on one side of the reel: "PART NUMBER", "LOT NUMBER", "QUANTITY", "DATE OF MANUFACTURE", "CUSTOMER'S NAME"
- There will be following indication on the reel box: "PART NUMBER", "LOT NUMBER", "QUANTITY OF REEL", "DATE OF MANUFACTURE", "CUSTOMER'S NAME"
- We adequately pack the box to prevent chip capacitor from any mechanical damage during transportation.



Precautions

Handling

- 1) Cracks may occur unless otherwise avoiding excessive stress to the capacitors by the load of an adsorption nozzle, and bending of a substrate at the time of mounting.
- 2) Please arrange the capacitor position where they don't have too much stress of board bending after mounting.
- 3) Please design that the form and size of the land pattern has suitable solder amount.

 Otherwise cracks may occur. The recommended fillet height shall be 1/2 to 1/3 of the thickness of capacitors.

■ Circuit Design

- 1) When AC voltage is superimposed on DC voltage, the zero-to-peak voltage shall not exceed the rated voltage. When the capacitor is to be employed in a circuit in which there is continuous application of a high frequency Voltage or a steep pulse voltage, even though it is within the rated voltage, please inquire to the manufacturer.
- 2) Please use the capacitor below the maximum temperature. When using the capacitor in a self-heating AC circuit, please make sure the surface of the capacitor remains under the maximum temperature for usage. Also, please make certain temperature rises remain below 20 °C.

Resin coating

Please use the resin of low curing shrinkage type. (Otherwise cracks may occur).

■ Storage

- 1) When the components is stored in minimal packaging (a heat-sealed or chuck-type plastic bag), the bag should be kept closed. Once the bag has been opened, reseal it or store it in a desiccator.
- 2) Keep storage place temperature +5 to +40 °C, humidity 20 to 70% RH.
- 3) The storage atmosphere must be free of gas containing sulfur and chlorine. Also, avoid exposing the product to saline moisture. If the product is exposed to such atmospheres, the terminals will oxidize and solderability will be effected.
- 4) Precautions 1) to 3) apply to chip capacitors packaged in carrier tapes and bulk cases.
- 5) The solderability is assured for 6 months from our shipping date if the above storage precautions are followed.

Application Restriction

Please consult with us before using a capacitor in the equipment which requires a high degree reliability (medical equipment, aerospace applications, nuclear equipment.) Malfunctions in medical, space, nuclear power or other vital equipment may result in death or great social losses. Capacitors designed specially with high reliability are used for the equipment above.

■ Export regulation

When the applying products relate the strategic materials which are provided in Foreign Exchange and Foreign Trade Act and Foreign Trade Management Law, the export license based on these laws are required.

Disposal

Please dispose the capacitors according to the relating laws about the waste treatment and cleaning. Safety application guideline and detailed information of electrical properties are also provided in Kyocera home page:

URL: http://www.kyocera.co.jp/electronic/

Notice:

This specification shall guarantee only monolithic capacitors. Please make sure the performance of capacitors after mounted on the assembled product.

Any failures occurred being used out of this specification shall not be quaranteed.

This specification shall be applied to the products purchased through the regular sales routes, such as the sale offices, the subsidiaries and the distributors, etc.).



单击下面可查看定价,库存,交付和生命周期等信息

>>Kyocera(京瓷)